

C1206X824K5RACTU

Aliases (C1206X824K5RAC7800)

SMD Comm X7R Flex, Ceramic, 0.82 uF, 10%, 50 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1206



Click here for the 3D model.

Dimensions		
Chip Size	1206	
L	3.3mm +/-0.4mm	
W	1.6mm +/-0.35mm	
Т	1mm +/-0.20mm	
В	0.6mm +/-0.25mm	

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	2500	

General Information	
Series	SMD Comm X7R Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.82 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	609.8 MOhms

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